SEP 1 2 2005

# IN THE UNITED STATES PATENT & TRADEMARK OFFICE

10/724,127

Confirmation No. 1216

**Applicant** 

Myung Gyu CHOI

Filed

12/01/2003

Tech Cntr/AU

2823

Examiner

Trinh, Michael Manh

**Entitled** 

METHOD OF FORMING WELL IN SEMICONDUCTOR DEVICE

Attorney Reference

123034-05004909

Customer Number

43569

MAIL STOP AF

Commissioner for Patents

P.O. Box 1450

Alexandria, Virginia 22313-1450

# AMENDMENT/RESPONSE TRANSMITTAL

Transmitted herewith is an amendment/response for this application.

## **EXTENSION OF TIME**

A petition for extension of time under 37 C.F.R. 1.136 is not believed necessary.

#### **CLAIM FEES**

The claim fees have been calculated as follows:

	CLAIMS									
	REMAINING AFTER AMENDMENT	HIGHEST NO. PREVIOUSLY PAID FOR		PRESENT EXTRA		RATE		ADDITIONAL FEE		
Total	5	_	20	=	0	x \$	50.00	=	\$	0.00
Independent	2	_	3	=	0	x \$	200.00	=	\$	0.00
	FIRST PRES	ENTATIC	N OF MULT	IPLE DE	P. CLA	IM+ \$	360.00	=	\$	0.00
			тот	AL ADD	ITIONA	L CLAIM	FEE DUE		\$	0.00

### **FEE PAYMENT**

Authorization is given herein to charge the any deficiencies in the fees not specifically authorized herein, or to further credit any overpayments, to Deposit Account No. 503-121 in order to maintain the pendency of this application.

Intellectual Property Department Mayer Brown Rowe & Maw LLP 1909 K Street, N.W. Washington, D.C. 20006-1101

Yoon S. Ham Registration No. 45,307

(202) 263-3280

Date: September 12, 2005

/ THE UNITED STATES PATENT & TRADEMARK OFFICE

Application Number

10/724,127

Confirmation No. 1216

**Applicant** 

Myung Gyu CHOI

Filed

December 1, 2003

Tech Cntr/AU

2822

Examiner

Michael Manh Trinh

**Entitled** 

METHOD OF FORMING WELL IN SEMICONDUCTOR

**DEVICE** 

Attorney Reference

123034-05004909

Customer Number

43569

## **MAIL STOP AF**

**Commissioner for Patents** 

P.O. Box 1450

Alexandria, Virginia 22313-1450

# RESPONSE UNDER 37 C.F.R. § 1.116

Sir:

In response to the Final Office Action dated July 12, 2005 for the above-identified application, amendments and/or remarks submitted herewith include:

- · A complete claim listing; and
- Remarks and arguments.